MAGNETIC AND NANOSTRUCTURAL CHARACTERISTICS OF ELECTRODEPOSITED SUPERMALLOY (Ni-Fe-Mo) THIN FILMS

G. NABIYOUNI1, SH. SAEIDI1 and I. KAZEMINEZHAD2

1Department of Physics
Faculty of Science
Arak University
Arak 38156-8-8349
Iran
e-mail: g-nabiyouni@araku.ac.ir

2Department of Physics
Faculty of Science
Shahid Chamran University
Ahvaz
Iran

Abstract

We have prepared supermalloy (Ni-Fe-Mo) thin films by using electrodeposition method. Electrodeposition is a simple, flexible, and inexpensive technique for fabricating the metallic thin films, which does not require complex and expensive vacuum apparatus and the deposition usually takes place in the ambient temperature. By this method, individual layers, multilayer, and magnetic alloy layers have been produced in ambient conditions. In this work,

Keywords and phrases: supermalloy, electrodeposition, magnetic properties.

Communicated by Jifan Hu.

Received May 19, 2012; Revised June 26, 2012
deposition took place in a single electrolyte containing $\text{Ni}^{2+}, \text{Fe}^{3+},$ and $\text{Mo}^{2+}$ ions, under potentiostatic control (constant potential). Scanning electron microscopy (SEM) and energy dispersive X-ray analysis (EDX) techniques were employed to investigate the morphology and chemical composition of the films. The result indicates that the weight percent (wt.%) of Ni and Mo, decrease by increasing the film thickness, while the weight percent of Fe, increases as the film thickness increases. The magnetic properties of the supermalloy films have also been studied by using alternating gradient force magnetometer (AGFM).

1. Introduction

Many different techniques have been used to synthesis alloy and multilayered thin films. The structural and physical properties of the films, nevertheless, are highly dependent on their preparation methods. Thin films are most commonly prepared by vacuum based techniques, such as evaporation, sputtering, and molecular beam epitaxy (MBE). In these techniques, a material (metal, alloy or semiconductor) is evaporated or sputtered and deposited on a substrate to form a thin film. In MBE, under certain conditions, it is possible to grow one atomic layer after another, forming a nearly perfect single crystal with both a very smooth surface and sharp interface. However, the required equipment is complicated and expensive. Sputtering, which is less complicated and less expensive, has been widely used to produce thin films and multilayers, although the produced materials are not perfect single crystals and do not always have a smooth surface or very sharp interfaces. An alternative method widely used for metallic coatings, is electrodeposition. This method is simple, flexible, and economically low cost.

Although electrodeposited films first found widespread application as decorative and/or protective coatings, the method is now also widely used in the electronics industry to deposit conducting or magnetic layers. For example, electrodeposited Cu is now the material of choice for interconnects in ultra large scale integrated (ULSI) circuits [1], while electrodeposited soft magnetic alloys are an important component of magnetic recording heads.
Figure 1 illustrates the basic principle of electrodeposition. Two conducting electrodes are placed in an electrolyte containing ions of the metal or metals to be deposited. When the external power supply drives a current through the cell, metal ions are reduced to metal atoms at one of the electrodes, known as the cathode. For example, if the electrolyte contained dissolved Ni$^{2+}$, Fe$^{2+}$, and Mo$^{2+}$ ions, the cathode reaction would be:

\[
\begin{align*}
\text{Ni}^{2+}_{(\text{aqueous})} + 2e & \rightarrow \text{Ni}_{(\text{solid})}, \\
\text{Fe}^{2+}_{(\text{aqueous})} + 2e & \rightarrow \text{Fe}_{(\text{solid})}, \\
\text{Mo}^{2+}_{(\text{aqueous})} + 2e & \rightarrow \text{Mo}_{(\text{solid})}.
\end{align*}
\]

Making a thin layer of Ni-Fe-Mo alloy on the cathode (substrate).

A problem with electrodeposition is that during the metal deposition hydrogen is also reduced, and the amount could be significant especially, if a relatively high potential is applied between working and reference
electrodes. Thus, the charge passed between anode and cathode is not only due to metal deposition but also to hydrogen evolution, so the deposited layer thicknesses are less than those calculated assuming all the charge passed reduces metal (the nominal thicknesses). The current efficiency of the Ni-Fe-Mo electrolytes is found to be very low and rarely riches to 15%. We found the current efficiency of our electrolyte for deposition of Ni-Fe-Mo alloys is only 10%.

Many factors influence the growth of electrodeposited films, including the transport of ions to the cathode, the presence of adsorbed species on the cathode, and the diffusion of adatoms. According to Brenner’s explanation: When a less noble metal is professionally codeposited with a more noble metal, anomalous co-deposition occurred, i.e., the deposit contains the less noble metal in a higher concentration than expected from the electrolyte composition [2]. Electrodeposition of ferromagnetic alloys consists of Ni, Fe, and Co is an example of anomalous co-deposition. The co-deposition of Nickel and Molybdenum is also the same [2, 3].

Molybdenum cannot be electroplated from an aqueous solution by itself, but it is possible to co-deposit it with iron group metals; making molybdenum alloy thin films. These alloys have some interesting properties, such as a high corrosion resistance, high wear resistance, and low hydrogen evolution overpotential. Furthermore, metallic alloy films, which are composed of these magnetic and nonmagnetic elements have useful applications due to their magnetic properties, such as low coercivity, high permeability, and high flux density [4-9]. We have successfully electrodeposited Ni-Fe-Mo alloy from an aqueous solution containing Ni^{2+}, Fe^{2+}, and Mo^{2+} ions. Structural and magnetic properties of the electrodeposited supermalloy thin films are presented in this paper.

2. Experimental

The deposition took place at room temperature under potentiostatic control in a single electrolyte containing three electrodes at pH of 1.8. The bath compositions for electroplating films are given in Table 1.
Copper foil substrates were used as the cathode with a surface area of \(1.5 \times 1.5\) cm\(^2\). In order to control the electroplating process, exposing area was chosen as a circle with 10mm in diameter. Prior to electrodeposition, the substrates were mechanically and electrochemically polished. The electropolishing process was carried out in a 50\% H\(_3\)PO\(_4\) solution and applying a positive DC potential of 1.8–2V on the substrate. This process removes a very top oxidized layer of Cu from the surface and makes the substrate surface absolutely clean and shiny. The substrate then rinsed with double distilled water and placed into electrolyte immediately to prevent substrate from any oxidation and contamination.

<table>
<thead>
<tr>
<th>Component</th>
<th>Quantity</th>
</tr>
</thead>
<tbody>
<tr>
<td>NiSO(_4), 6H(_2)O</td>
<td>60g l(^{-1})</td>
</tr>
<tr>
<td>FeSO(_4), 7H(_2)O</td>
<td>4g l(^{-1})</td>
</tr>
<tr>
<td>Na(_2)MoO(_4), 2H(_2)O</td>
<td>2g l(^{-1})</td>
</tr>
<tr>
<td>NaCl</td>
<td>10g l(^{-1})</td>
</tr>
<tr>
<td>C(_6)H(_5)O(_7)(Citric acid)</td>
<td>66g l(^{-1})</td>
</tr>
<tr>
<td>C(_7)H(_5)NO(_3)S(Saccharin)</td>
<td>3g l(^{-1})</td>
</tr>
</tbody>
</table>

In order to decrease the ohmic resistance and preventing from potential drop in the electrolyte, working electrode is located quite close to the reference electrode, while the working and secondary electrodes are located parallel and far from each other (about 10cm). Electrochemical reaction starts by switching on the computer control potentiostat and applying a constant potential. Computer measures the deposition current between cathode and anode and integrate it over the time until the passed charge between cathode and anode reaches to a certain amount corresponds to a desired film thickness. The amount of charge is calculated according to Faraday’s equation [10].
\[ q = \frac{nF\rho Ah}{M}, \quad (2) \]

where \( F = 96485\text{C/Mol} \) is Faraday’s constant, \( h \) is thickness, \( A \) is exposed area, \( n \) is valence, \( \rho \) is atomic density, and \( M \) is atomic mass.

The optimum voltage for depositing of Ni-Fe-Mo alloy layers was found to be \(-1.35\text{V}\). After deposition, the supermalloy films were rinsed in ultra pure water and dried with \( \text{N}_2 \) gas. The films are now ready for characterization and magnetic studies.

3. Results and Discussions

The composition of the alloy films was measured by using energy dispersive X-ray (EDX) analysis. The result is presented in Figure 2. Different weight percent of Ni, Fe, and Mo have been achieved by changing the thicknesses from \( 0.6\mu\text{m} \) to \( 2.1\mu\text{m} \). Scanning electron microscopy (SEM) was employed to study the surface morphology of the samples. SEM images are given in Figure 3. The figures reveal that, by increasing the film thickness, the film surface becomes granular. Ni-Fe-Mo alloy layers with higher amount of molybdenum and nickel (in weight percent) are more suitable for coating the substances in order to make them highly corrosion resistance. For this application, the sample with the thickness of \( 0.6\mu\text{m} \) is a good candidate.
**Figure 2.** Weight percent of Ni, Fe, and Mo versus thickness.
The crystalline structure of films prepared by electrodeposition method was verified by X-ray diffraction (XRD). Figure 4 shows a typical XRD pattern for a supermalloy film electrodeposited on a Ti plate substrate. The reason for choosing a Ti plate substrate is that the films can be easily pilled out from its substrate and get rid of the substrate
peaks in the XRD patterns. The XRD patterns show four narrow peaks at $2\theta = 38.5^\circ$, $44.7^\circ$, $65.1^\circ$, and $78.21^\circ$, respectively, indicating crystalline structure of the electrodeposited supermalloy.

![X-ray diffraction pattern](image)

**Figure 4.** X-ray diffraction pattern of the stripped Ni-Fe-Mo alloy film.

In order to assess the suitability of our samples for micromachined magnetic devices, we studied the M-H characteristics, coercivity, saturation magnetic moment, and remanence magnetic moment by using an alternative gradient force magnetometer (AGFM). As can be found from the EDX results, the amounts of Ni and Mo decrease and the weight percent of iron increases with increasing of the film thickness, and consequently affect on the magnetic properties of layers. The results are demonstrated in Figures 5 and 6. The figures represent hysteresis loops of the samples while the applied magnetic field is either parallel or perpendicular to the film surface.
Figure 5. Hysteresis loops for the samples with magnetic field parallel to the film surface. The films’ thickness are $C_1 = 0.6\mu m$, $C_2 = 0.9\mu m$, $C_3 = 1.2\mu m$, $C_4 = 1.5\mu m$, $C_5 = 1.8\mu m$, and $C_6 = 2.1\mu m$. 
Figure 6. Hysteresis loops for the samples with magnetic field perpendicular to the film plane. The films’ thickness are $C_1 = 0.6\mu m$, $C_2 = 0.9\mu m$, $C_3 = 1.2\mu m$, $C_4 = 1.5\mu m$, $C_5 = 1.8\mu m$, and $C_6 = 2.1\mu m$.

Increasing the amount of iron in the films, makes the hysteresis loop narrow and leads to increase the saturation magnetic moment and enhancement of soft magnetic properties of layers.

In parallel field, all of the samples are saturated in nearly same fields. By adding a few percentage of molybdenum to nickel-iron composition, the domains can be easily aligned with the applied external magnetic field and caused high permeability. In addition, due to the function of molybdenum ions as electron-scattering centers, the electrical resistivity enhances. By increasing of electrical resistivity, eddy currents will be reduced. This decrease in eddy currents result in high permeability so that, the magnetic field caused by these internal eddy currents acts against the applied magnetic field and have the effect of reducing the internal flux density [4]. In other words, the hysteresis loop
reaches saturation sooner when Mo percent increases. The results appear in M-H curves of the thinner films in Figures 5 and 6. Comparing these figures, one can see that the hysteresis loops saturate in the higher field when the field is perpendicular to the film surface than when it is parallel, suggesting an existence of magnetic anisotropy, with an easy axis parallel and a hard axis perpendicular to the film plane.

Tables 2 and 3, respectively, give a comparison between magnetic characteristics of Ni-Fe-Mo alloy films when the applied magnetic field is parallel and perpendicular to the film plane. The figures in the tables also indicate that, the remanence magnetic moment in perpendicular configuration is higher than those in the parallel configuration. In addition, in both parallel and perpendicular configurations, coercivity decreases when the film thickness changes from 0.6µm to 1.5µm, then rises again by increasing the film thickness from 1.5µm to 2.1µm. The reason of this irregular change can be attributed to the amount of deposited molybdenum in the films and existence of some impurities in the electrolyte.

**Table 2.** Magnetic characteristics of Ni-Fe-Mo alloy films in parallel applied magnetic field

<table>
<thead>
<tr>
<th>Thickness (µm)</th>
<th>Coercivity (Oe)</th>
<th>Remanence magnetic moment (emu)</th>
<th>Saturation magnetic moment (emu)</th>
</tr>
</thead>
<tbody>
<tr>
<td>0.6µm</td>
<td>13.13</td>
<td>7.14 E-4</td>
<td>0.00356</td>
</tr>
<tr>
<td>0.9µm</td>
<td>12.12</td>
<td>16.51 E-4</td>
<td>0.00427</td>
</tr>
<tr>
<td>1.2µm</td>
<td>5.05</td>
<td>13.02 E-4</td>
<td>0.00499</td>
</tr>
<tr>
<td>1.5µm</td>
<td>5.05</td>
<td>21.14 E-4</td>
<td>0.00904</td>
</tr>
<tr>
<td>1.8µm</td>
<td>7.79</td>
<td>20.44 E-4</td>
<td>0.01161</td>
</tr>
<tr>
<td>2.1µm</td>
<td>6.06</td>
<td>35.70 E-4</td>
<td>0.01938</td>
</tr>
</tbody>
</table>
Table 3. Magnetic characteristics of Ni-Fe-Mo alloy films in perpendicular applied magnetic field

<table>
<thead>
<tr>
<th>Thickness (µm)</th>
<th>Coercivity (Oe)</th>
<th>Remanence magnetic moment (emu)</th>
<th>Saturation magnetic moment (emu)</th>
</tr>
</thead>
<tbody>
<tr>
<td>0.6</td>
<td>68.69</td>
<td>15.87 E-4</td>
<td>0.01822</td>
</tr>
<tr>
<td>0.9</td>
<td>36.37</td>
<td>22.75 E-4</td>
<td>0.03068</td>
</tr>
<tr>
<td>1.2</td>
<td>56.57</td>
<td>21.41 E-4</td>
<td>0.01976</td>
</tr>
<tr>
<td>1.5</td>
<td>12.12</td>
<td>45.24 E-4</td>
<td>0.04404</td>
</tr>
<tr>
<td>1.8</td>
<td>16.16</td>
<td>40.48 E-4</td>
<td>0.04412</td>
</tr>
<tr>
<td>2.1</td>
<td>40.40</td>
<td>103.31 E-4</td>
<td>0.09006</td>
</tr>
</tbody>
</table>

4. Conclusion

In summary, Ni-Fe-Mo alloy magnetic films were fabricated on Cu and Ti substrates by electrodeposition technique. The structure and morphology of the layers were characterized by using SEM, EDX, and XRD analyses. XRD patterns reveal the crystalline structure of the deposited layers. The percentage weight of Ni, Fe, and Mo in the deposited alloys varies with the film thickness. The magnetic properties of the Ni-Fe-Mo alloy films have been studied by using AGFM with the applied field parallel and perpendicular to the film plane. The results reveal of the existence of a magnetic anisotropy with an easy axis parallel and a hard axis perpendicular to the film plane.

References


